## 74LVC240A

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

Rev. 8 — 29 November 2011

**Product data sheet** 

### 1. General description

The 74LVC240A is an octal inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

The 74LVC240A is functionally identical to the 74LVC244A except that the 244 has non-inverting outputs.

#### 2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



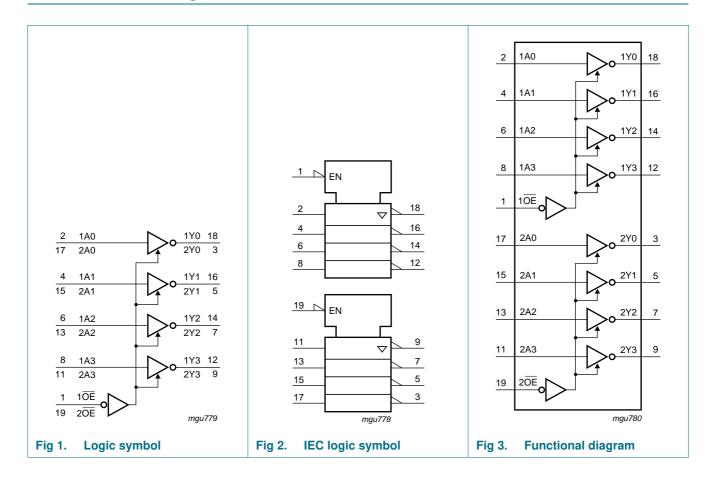
Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

## 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC240AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC240ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC240APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC240ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 $\times$ 4.5 $\times$ 0.85 mm	SOT764-1

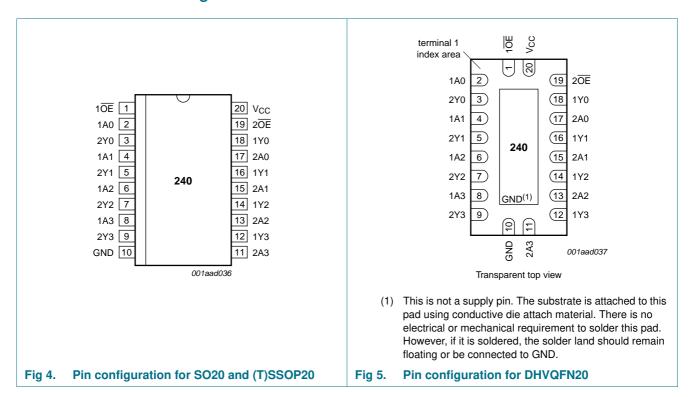
## 4. Functional diagram



Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

### 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 <del>OE</del>	1	output enable input (active LOW)
2 <del>OE</del>	19	output enable input (active LOW)
1A[0:3]	2, 4, 6, 8	data input
2A[0:3]	17, 15, 13, 11	data input
1Y[0:3]	18, 16, 14, 12	data output
2Y[0:3]	3, 5, 7, 9	data output
GND	10	ground (0 V)
V <sub>CC</sub>	20	power supply

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### 6. Functional description

Table 3. Function selection[1]

Inputs nOE		Output
nOE	nAn	nYn
L	L	Н
L	Н	L
Н	X	Z

<sup>[1]</sup> H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Max	Unit
supply voltage		-0.5	+6.5	V
input clamping current	V <sub>1</sub> < 0	-50	-	mA
input voltage		<u>[1]</u> –0.5	+6.5	V
output clamping current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
output voltage	output HIGH or LOW state	[ <u>2</u> ] -0.5	$V_{CC} + 0.5$	V
	output 3-state	[ <u>2</u> ] -0.5	+6.5	V
output current	$V_O = 0 V to V_{CC}$	-	±50	mA
supply current		-	100	mA
ground current		-100	-	mA
storage temperature		-65	+150	°C
total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	500	mW
	supply voltage input clamping current input voltage output clamping current output voltage  output current supply current ground current storage temperature	$\begin{array}{lll} & \text{supply voltage} \\ & \text{input clamping current} & V_{I} < 0 \\ & \text{input voltage} \\ & \text{output clamping current} & V_{O} > V_{CC} \text{ or } V_{O} < 0 \\ & \text{output voltage} & \text{output HIGH or LOW state} \\ & \text{output 3-state} \\ & \text{output current} & V_{O} = 0 \text{ V to } V_{CC} \\ & \text{supply current} \\ & \text{ground current} \\ & \text{storage temperature} \end{array}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

For (T)SSOP20 packages: above 60  $^{\circ}\text{C}$  derate linearly with 5.5 mW/K.

For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO20 packages: above 70 °C derate linearly with 8 mW/K.

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### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
V <sub>O</sub>	output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall	V <sub>CC</sub> = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

#### 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	٧
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	٧
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	٧
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	٧
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	٧
input voltage		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	٧
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	٧
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	٧
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V <sub>CC</sub> - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	٧
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	٧
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	٧
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	٧
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	٧
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	٧
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	٧
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	٧
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	٧
l <sub>l</sub>	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	S °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±10	-	±20	μА
l <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}$ ; $V_I \text{ or } V_O = 5.5 \text{ V}$	-	0.1	±10	-	±20	μА
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_{I}$ = $V_{CC}$ or GND; $I_{O}$ = 0 A	-	0.1	10	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	-	5000	μА
Cı	input capacitance	$V_{CC}$ = 0 V to 3.6 V; V <sub>I</sub> = GND to $V_{CC}$	-	5.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

### 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation	1An to 1Yn; 2An to 2Yn; see Figure 6	[2]					'	
	delay	V <sub>CC</sub> = 1.2 V		-	16	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.0	5.7	12.7	1.0	14.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	3.0	6.6	0.5	7.6	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.1	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.3	2.6	5.5	1.3	7.0	ns
t <sub>en</sub>	enable time	1OE to 1Yn; 2OE to 2Yn; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.3	15.9	1.5	18.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.6	8.8	1.5	10.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.7	8.5	1.0	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.1	2.9	7.0	1.1	9.0	ns
t <sub>dis</sub>	disable time	1OE to 1Yn; 2OE to 2Yn; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	17	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.3	4.1	9.9	2.3	11.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.4	5.6	1.0	6.5	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.1	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.4	2.9	6.0	1.4	7.5	ns
$t_{sk(o)}$	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
					Typ[1]	Max	Min	Max	
$C_PD$	power	per buffer; $V_I = GND$ to $V_{CC}$	1				•		'
	dissipation	V <sub>CC</sub> = 1.65 V to 1.95 V		-	2.0	-		-	pF
	capacitance	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	5.2	-		-	рF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	8.1	-		-	рF

- [1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.2$  V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- $\begin{array}{ll} [2] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

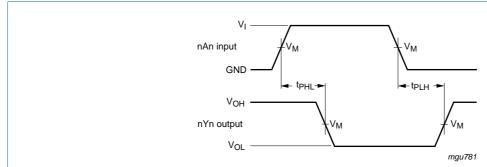
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs}$ 

#### 11. AC waveforms



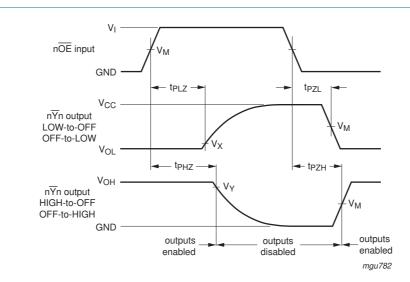
 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V};$ 

 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 \text{ V}$ ;

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 6. Inputs (1An, 2An) to outputs (1Yn, 2Yn) propagation delays

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state



 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$ 

 $V_{M} = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 \ V.$ 

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$ 

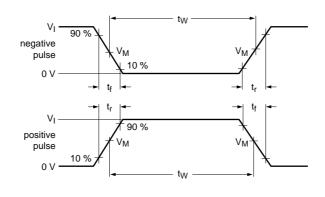
 $V_X = V_{OL} + 0.15 \text{ V at } V_{CC} < 2.7 \text{ V};$ 

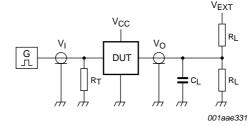
 $V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$ 

 $V_Y$  =V  $_{OH}$  - 0.15 V at  $V_{CC}$  < 2.7 V.

Fig 7. 3-state enable and disable times

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state





Test data is given in Table 8.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 8. Test data

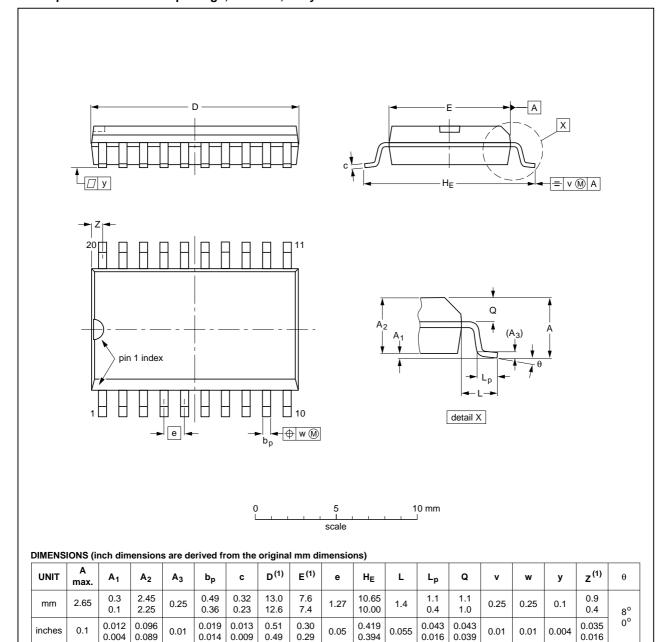
Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>				
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}$ , $t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>			
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting;

### 12. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

Fig 9. Package outline SOT163-1 (SO20)

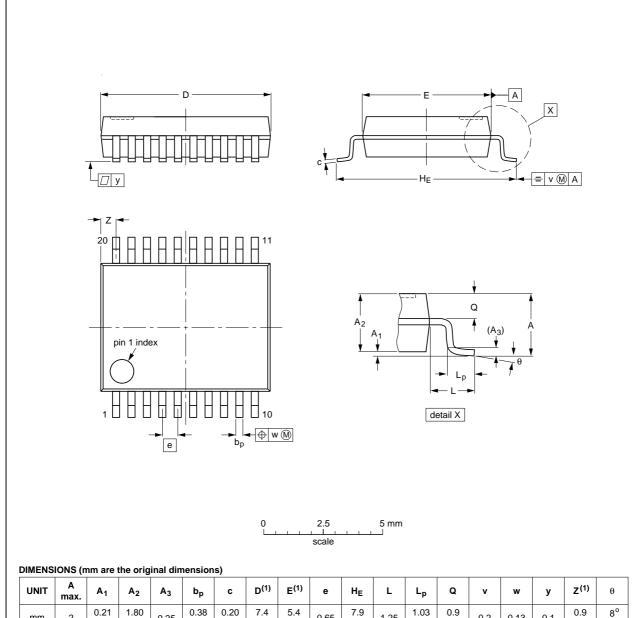
74LVC240A

74LVC240A **NXP Semiconductors** 

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

#### SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



						-,												
UNI	Г A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT339-1		MO-150				<del>99-12-27</del> 03-02-19

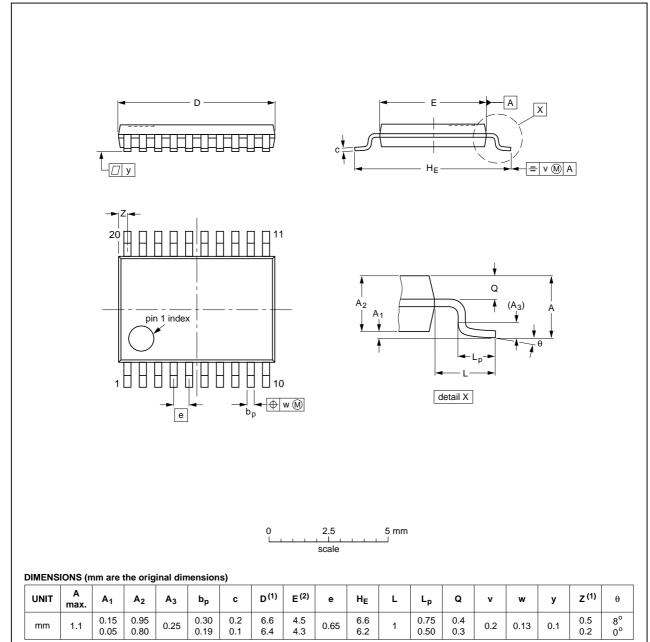
Fig 10. Package outline SOT339-1 (SSOP20)

74LVC240A

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

#### TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				<del>99-12-27</del> 03-02-19

Fig 11. Package outline SOT360-1 (TSSOP20)

74LVC240A

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Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

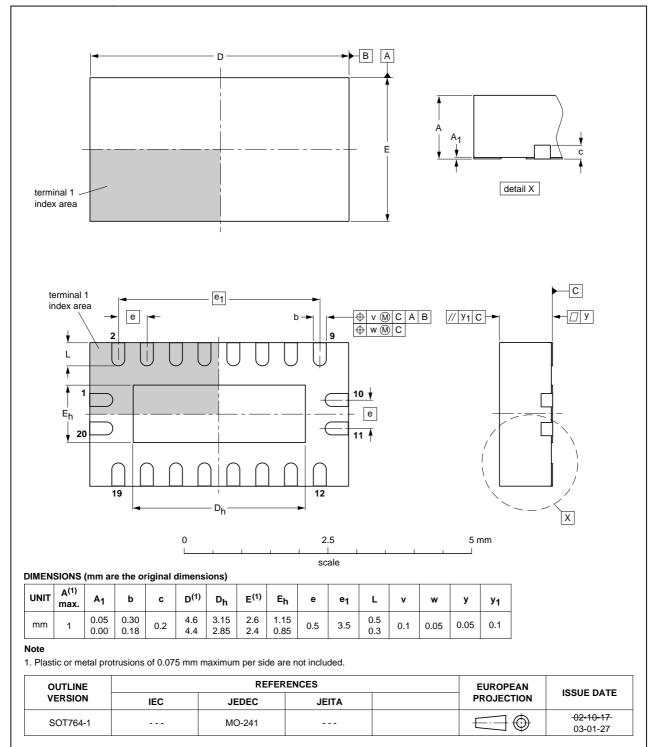


Fig 12. Package outline SOT764-1 (DHVQFN20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

### 13. Abbreviations

#### Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

#### Table 10. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC240 v.8	20111129	Product data sheet	-	74LVC240A v.7
Modifications:	• <u>Table 7</u> : maxin	num values for lower voltage ranç	ges changed (errata).	
74LVC240A v.7	20111027	Product data sheet	-	74LVC240A v.6
Modifications:		his data sheet has been redesign IXP Semiconductors.	ned to comply with the	new identity
	<ul> <li>Legal texts have</li> </ul>	ve been adapted to the new com	pany name where app	ropriate.
	• Table 4, Table	5, Table 6, Table 7 and Table 8: v	alues added for lower	voltage ranges.
74LVC240A v.6	20031202	Product specification	-	74LVC240A v.5
74LVC240A v.5	20030514	Product specification	-	74LVC240A v.4
74LVC240A v.4	20021220	Product specification	-	74LVC240A v.3
74LVC240A v.3	20021002	Product specification	-	74LVC240A v.2
74LVC240A v.2	19980520	Product specification	-	74LVC240A v.1
74LVC240A v.1	-	Product specification	-	-

## Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

### 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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